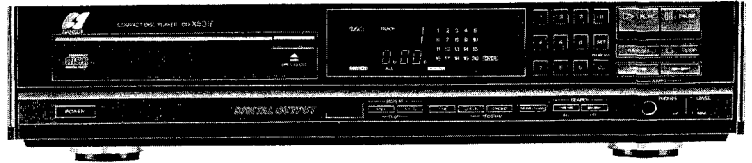


# SERVICE MANUAL

## CD-X501i COMPACT DISC PLAYER



### CAUTION

1. Parts identified by the  $\triangle$  symbol on the schematic diagram and the parts list are critical for safety.  
Use only replacement parts that have critical characteristics recommended by the manufacturer.
2. Make leakage-current or resistance measurements to determine that exposed parts are acceptably insulated from the supply circuit before returning the appliance to the customer.

### •SPECIFICATIONS

**Format** ..... Compact disc digital audio  
**Pick-up** ..... 3-beam, semiconductor laser  
**No. of channels** ..... 2 channels (stereo)  
**Decoding (D/A)** ..... 16-bit linear  
**Frequency response** ..... 4 Hz ~ 20 kHz  $\pm$ 0.3 dB  
**Total harmonic distortion** .. Less than 0.003% (1 kHz)  
**Signal-to-noise ratio (S/N)** .. Better than 106 dB  
**Dynamic range** ..... Better than 97 dB  
**Wow and flutter** ..... Below measurable limit  
**Output voltage/load impedance**  
   Normal output (LINE OUT)  
     ..... 2V/10 kohms  
   Digital output (DIGITAL OUT)  
     .....  $0.5 \pm 0.1V_{p-p}/75$  ohms  
   Headphones ..... 45 mW (variable maximum)/  
     with 32-ohms load  
**Power requirements** ..... AC 120V/220V/240V,  
     50/60 Hz  
   For U.S.A. & Canada .. AC 120V, 60 Hz

**Power consumption** ..... 16 watts  
**Dimensions** ..... 448 mm (17-11/16") W  
     98 mm (3-7/8") H  
     317 mm (12-1/2") D  
**Weight** ..... 5.4 kg (11.9 lbs) net

#### Remote controller: RS-1020

**Control system** ..... Infra-red ray pulse system  
**Power requirements** ..... DC 3V  
**Dimensions** ..... 63 mm (2-1/2") W  
     18 mm (3/4") H  
     148 mm (5-7/8") D  
**Weight** ..... 115 g (0.3 lbs)  
     including dry batteries

- \* Design and specifications subject to changes without notice for improvements.
- \* Due to local laws and regulations, this unit sold in some areas are not equipped with variable voltage selectors.

**NOTE**

1. The symbols, UL, CSA, SA, BS, UK, EU, AS, SEV, SS and XX <EXPORT> on the parts list and the schematic diagram mean followings respectively.

- UL..... Manufactured for U.S.A market.  
(Underwriters Laboratories approved model.)
- CSA ..... Manufactured for Canadian market.
- SA..... Manufactured for South African market.
- BS, UK..... Manufactured for United Kingdom market.
- EU..... Manufactured for European market.
- AS..... Manufactured for Australian market.
- SEV..... Manufactured for Swiss market.
- SS..... Manufactured for Saudi Arabia market.
- XX..... Standard Version.
- <EXPORT>
- NON MARK..... Common Parts.

2. Some printed circuit boards are not supplied assembled. To separate these in this service manual, the stock numbers are not indicated for these boards. However, stock numbers for individual parts are indicated.

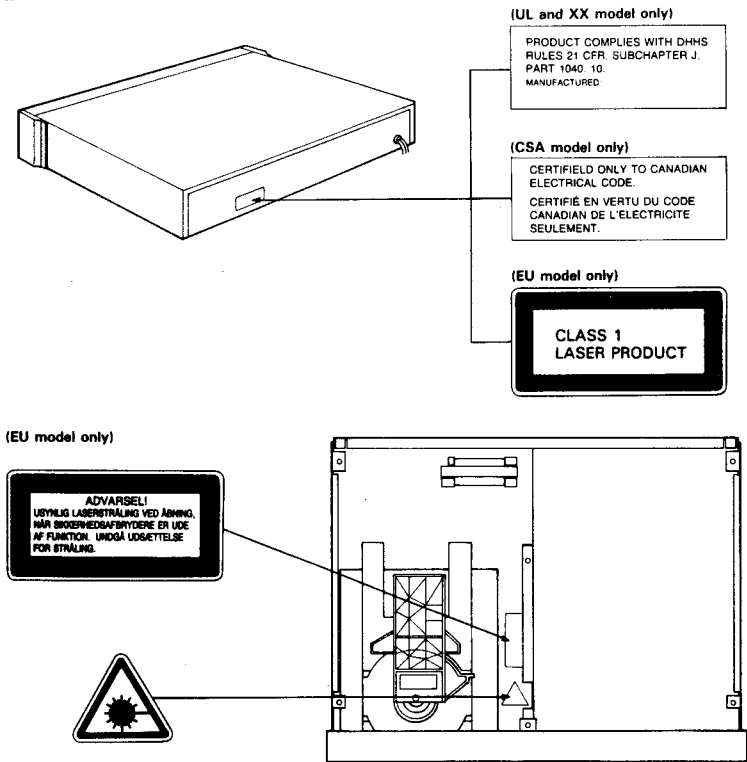
3. Since some capacitors and resistors are omitted from parts lists in this service manual, refer to the Common Parts List for capacitors and resistors, which was issued on June 1987.

4. Abbreviations in this service manual are as follows.

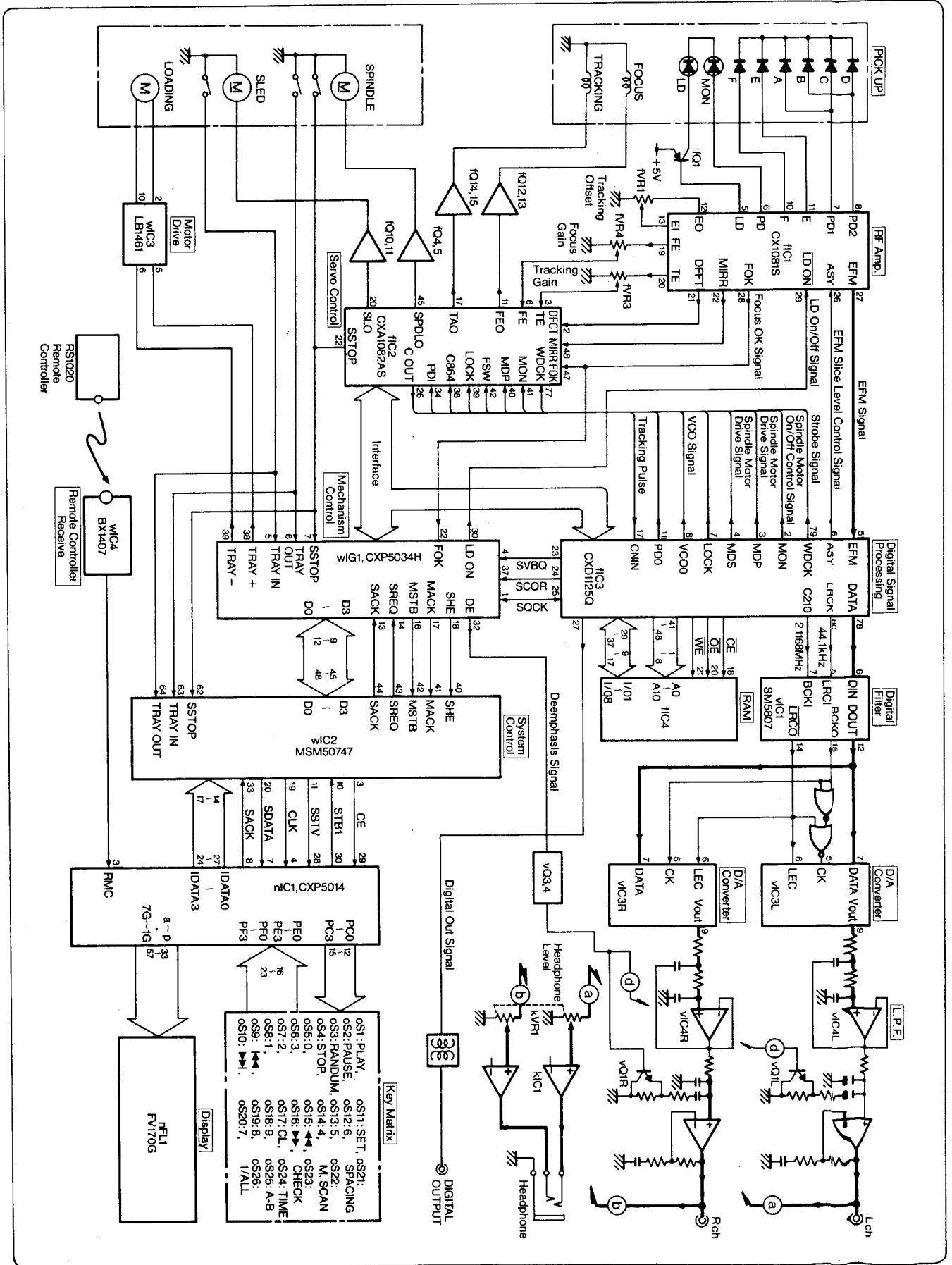
•Abbreviations List	
C.R.	: Carbon Resistor
S.R.	: Solid Resistor
Ce.R.	: Cement Resistor
M.R.	: Metal Film Resistor
F.R.	: Fusing Resistor
N.I.R.	: Non-Inflammable Resistor
A.R.	: Array Resistor
C.C.	: Ceramic Capacitor
C.T.	: Ceramic Capacitor, Temperature Compensation
E.C.	: Electrolytic Capacitor
E.L.	: Low Leak Electrolytic Capacitor
E.B.	: Bi-Polar Electrolytic Capacitor
E.B.L.	: Low Leak Bi-Polar Electrolytic Capacitor
Ta.C.	: Tantalum Capacitor
F.C.	: Film Capacitor
M.P.	: Metalized Paper Capacitor
P.C.	: Polystyrene Capacitor
M.M.C.	: Metalized Mylar Capacitor
A.C.	: Array Capacitor
V.R.	: Variable Resistor
S.V.R.	: Semi Variable Resistor
SW.	: Switch
Chip R.	: Chip Resistor
Chip C.	: Chip Capacitor

**Cautions Concerning Handling of The Laser**

The following table has been affixed to the unit, listing the proper procedure for working with the laser beam.

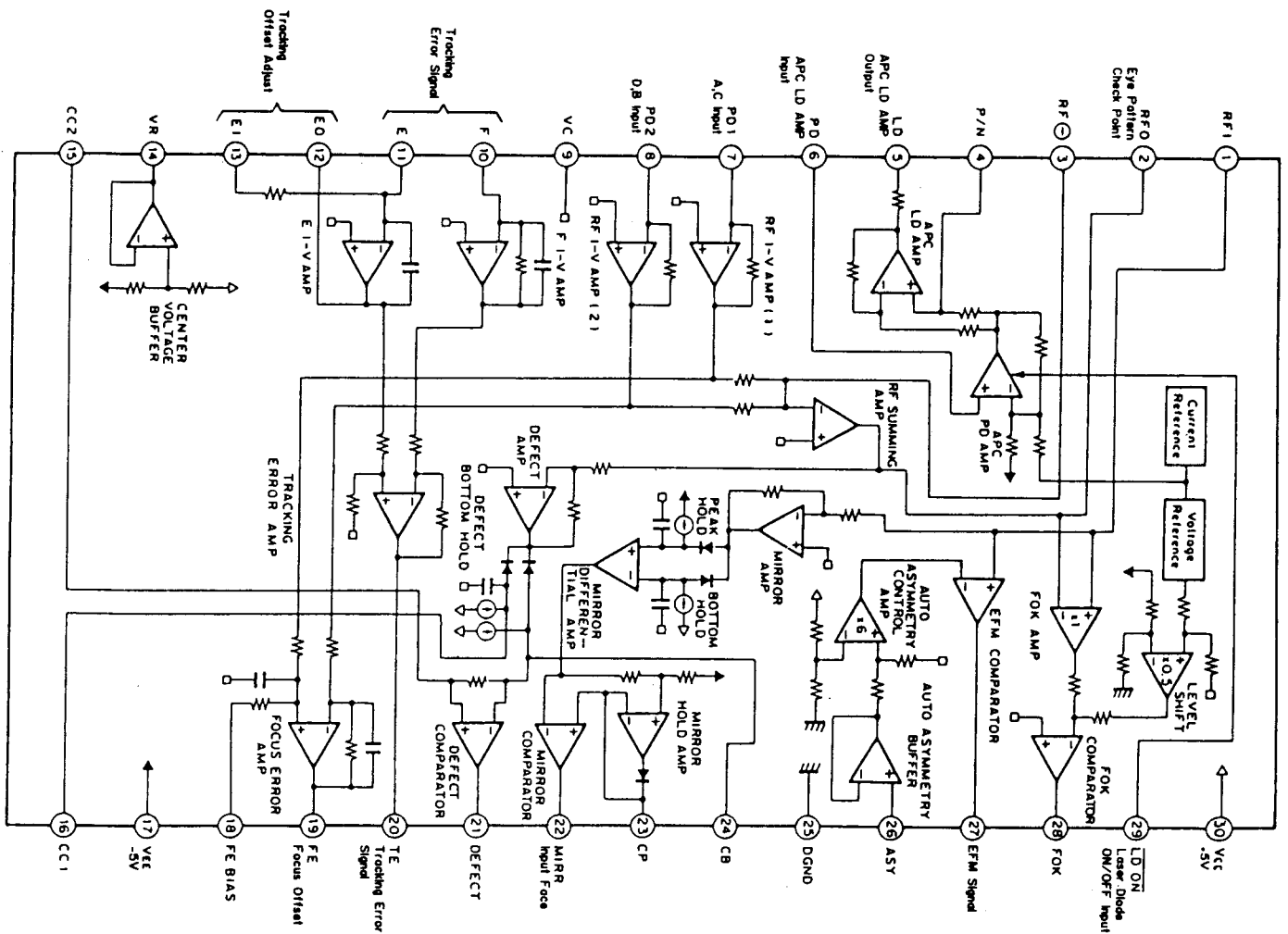


# 1. BLOCK DIAGRAM



## 2. INTERIOR BLOCK DIAGRAM AND TERMINAL FUNCTION OF IC

### •CX A1081S (RF Amp.)

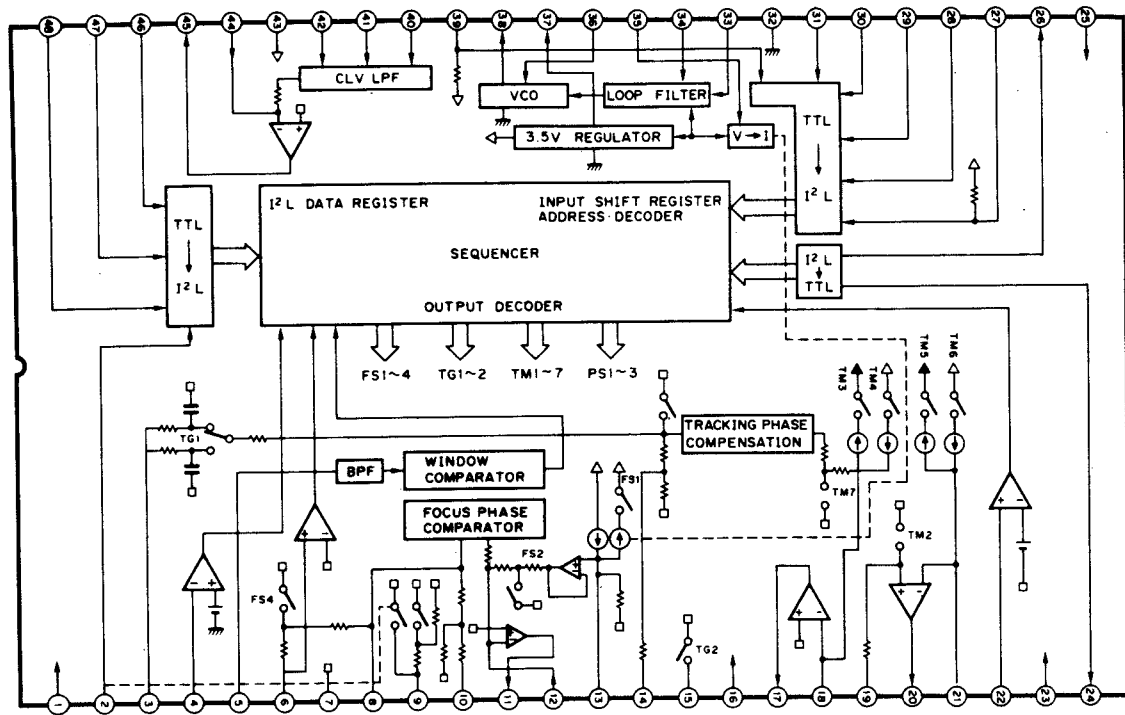


#### ◆ Terminal Function <CX A1081S>

Pin No.	Pin Name	I/O	Description
1	RFI	I	RF summing amplifier input.
2	RFO	O	RF summing amplifier output.
3	RF ⊖	I	RF Summing amplifier feedback signal input.
4	P/N	I	Terminal for switching P-sub/N-sub of LD (laser diode).
5	LD	O	APC LD amplifier output.
6	PD	I	APC PD amplifier input.
7	PD1	I	RF I-V amplifier (1) inverting input. This terminal is connected to the pin diode (A + C).
8	PD2	I	RF I-V amplifier (2) inverting input. This terminal is connected to the pin diode (B + D).
9	VC	-	Ground
10	F	I	F I-V amplifier inverting input. This terminal is connected to the pin diode (F).
11	E	I	E I-V amplifier inverting input. This terminal is connected to the pin diode (E).
12	EO	O	E I-V amplifier output.
13	EI	I	E I-V amplifier feedback input.
14	VR	O	(Vcc + VEE)/2 voltage output.

Pin No.	Pin Name	I/O	Description
15	CC2	I	Defect amplifier bottom hold input. This terminal is connected Pin 16 with a coupling capacitor.
16	CC1	O	Defect amplifier bottom hold output.
17	VEE	-	Negative supply voltage: -5V.
18	FEBIAS	I	Bias terminal for the focus error amplifier non-inverting.
19	FE	O	Focus error amplifier output.
20	TE	O	Tracking error amplifier output.
21	DEFECT	O	Defect comparator output.
22	MIRR	O	Mirror comparator output.
23	CP	I	Mirror comparator non-inverting input. This terminal is connected a mirror hold capacitor.
24	CB	I	This terminal is connected a defect bottom hold capacitor.
25	DGND	-	Ground.
26	ASY	I	Auto asymmetry buffer control signal input.
27	EFM	O	EFM comparator output.
28	FOK	O	FOK comparator output.
29	LD ON	I	Laser diode ON/OFF switching input.
30	Vcc	-	Positive supply voltage: +5V.

•CXA1082AS (Servo Control)

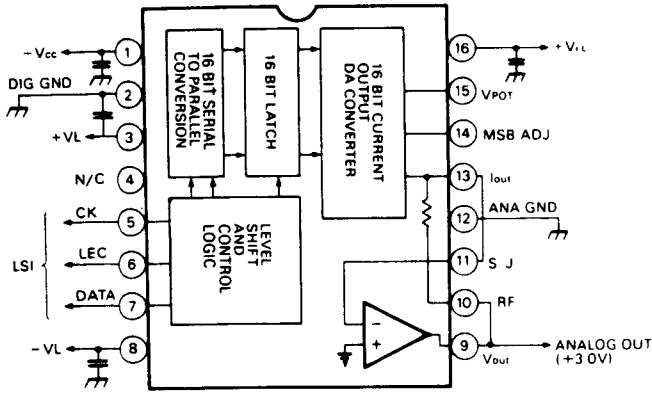


◆ Terminal Function <CXA1082AS>

Pin No.	Pin Name	I/O	Description
8	FGD	I	A capacitor is connected between this Pin and F3 ( Pin 9) for decreasing high-frequency gain of focus servo.
9	FS3	O	Terminal for switching high-frequency gain of focus servo.
10	FLB	-	This Pin is used to connect a time constant for increasing low-frequency characteristic of focus servo.
11	FEO	O	Terminal for outputting a signal for driving focus coil.
17	TAO	O	Terminal for outputting a signal for driving tracking coil.
20	SLD	O	Terminal for outputting a drive signal for sled motor.
45	SPDLO	O	Terminal for outputting a drive signal for spindle (disc) motor.
12	FE ⊖	I	Focus amplifier inverting input.
13	SRCH	I	This terminal is used to determine time constant for generating focus search waveform.
14, 15	TGU, TG2	-	Terminals are used to determine a time constant for switching tracking high-frequency gain.
18	TA ⊖	I	Tracking amplifier inverting input.
19	SL ⊕	I	Sled (Feed) amplifier non-inverting input.
21	SL ⊖	I	Sled amplifier inverting input.
22	SSTOP	I	Terminal for inputting a signal from limit switch ON/OFF for detecting innermost track of disc.
23	FSET	I	Terminal for setting focus and tracking phase-compensation peaks and fo of CLV LPF.
24	SENS	O	Terminal for outputting internal condition data.
26	C.OUT	O	Terminal for outputting a signal for counting track number of disc.
27	DIRC	-	This terminal is used for one-track jump operation.
28	XRST	-	Terminal for inputting a reset signal. Reset operation in "L" level.
29	DATA	I	Serial data input from the CXP5034H mechanism control.

Pin No.	Pin Name	I/O	Description
30	XLT	I	Terminal for inputting a latch signal for serial data from the CXP5034H mechanism control.
31	CLK	I	Serial data clock input the CXP5034H mechanism control.
32	DGND	-	Ground.
34	PDI	I	PDO signal input from the phase-comparator of the CXD1125Q digital signal processing.
35	ISET	O	Terminal for outputting a current to determine focus search, track jump and slewing kick height.
36	VCOF	I	VCO free-frequency is practically proportional to resistance between this Pin and Pin 37.
38	C864	O	Internal 8.64 MHz VCO output.
40	MDP	I	A spindle motor driving signal input from the CXD1125 digital signal processing (MDP terminal).
41	MON	I	A spindle motor ON/OFF signal input from the CXD1125 digital signal processing (MON terminal).
42	FSW	-	This terminal is used to determine a time constant for LPF of CLV servo error signal.
44	SPDL ⊖	I	Spindle drive amplifier inverting input.
46	WDCK	I	Auto sequence clock input Typical frequency = 88.2 kHz.
47	FOK	I	FOK signal input from the CXA1081S.
48	MIRR	I	Mirror comparator signal input from the CXA1081S.
2	DFCT	I	Defect comparator signal input from the CXA1081S.
3	TE	I	Tracking error amplifier signal input from CXA1081S.
4	TZC	I	Tracking zero cross comparator signal input.
5	ATSC	I	Window comparator input for ATSC detection.
6	FE	I	Focus error amplifier signal input.

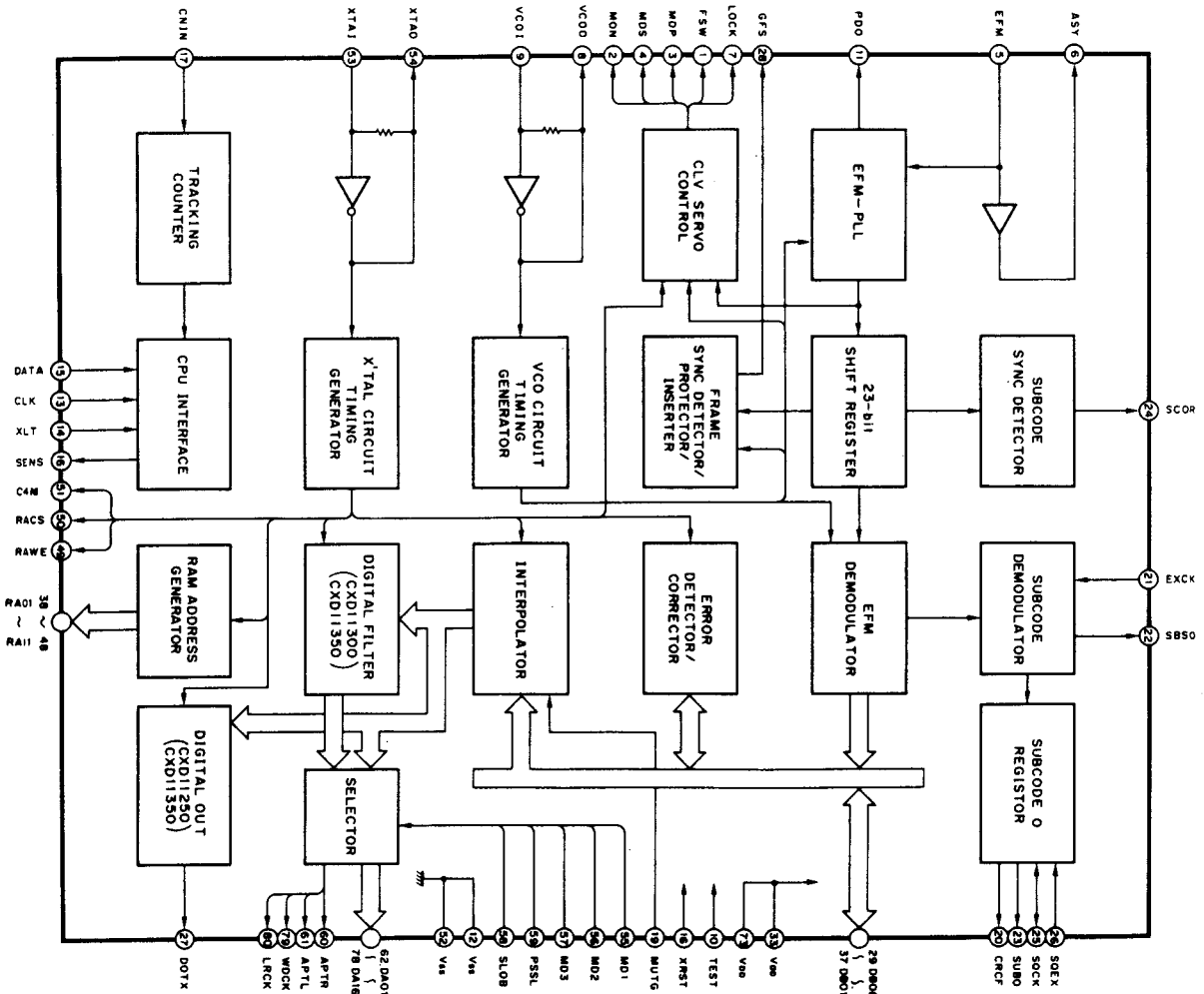
•PCM56 (16 bit D/A Converter)



◆ Terminal Function < PCM56 >

Pin No.	Pin Name	I/O	Description
1	-Vcc	-	Negative supply voltage: -5V.
2	DIG GND	-	Digital ground.
3	+VL	-	Positive supply voltage: +5V.
5	CK	I	Input data clock. The rising edge of this clock defines input data valid.
6	LEC	I	Latch enable control input.
7	DATA	I	Data input. Each data is in two's complement format with the most-significant bit first.
8	-VL	-	Negative supply voltage for logic circuit.
9	Vout	O	Analogue output.
10	RF	-	This terminal is used to connect a resistor for feedback.
11	S·J	I	Summing Junction (Operational amplifier input).
12	A GND	-	Analogue ground.
13	I OUT	O	Current output.
14	MSB ADJ.	-	This terminal is used for adjusting MSB.
15	V POT	-	This terminal is used to connect a potentiometer for MSB.
16	+Vcc	-	Positive supply voltage.

•CXD1125Q (Digital Signal Processing)



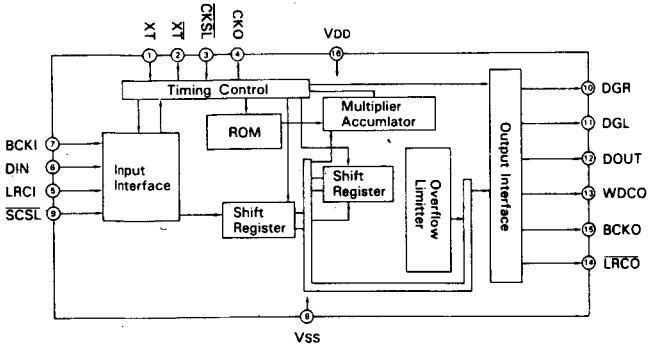
## ◆ Terminal Function &lt;CXD1125Q&gt;

Pin No.	Pin Name	I/O	Description
1	FSW	O	Terminal to output a time constant switching signal for output-filter of spindle motor.
2	MON	O	Terminal to output a control signal for spindle motor ON/OFF.
3	MDP	O	Spindle motor drive output. For CLV-S mode rough control and CLV-P mode phase control.
4	MDS	O	Spindle motor drive output. For CLV-P mode speed control.
5	EFM	I	Terminal to input a EFM signal from RF amplifier (CXA1081S).
6	ASY	O	Terminal to output a control signal for EFM signal slice level.
7	LOCK	O	The GFS signal is sampled at WFCK/16: if "H", "H" is output through this terminal. If "L" for 8 consecutive times, "L" is output.
8	VCOO	O	VCO output. When locked to the EFM signal, $f=8.6436$ MHz.
9	VCOI	I	VCO input.
10	TEST	I	(0 V).
11	PDO	O	Terminal to output a phase comparison signal for EFM signal and VCO/2.
12	VST	—	Ground (0 V)
13	CLK	I	Terminal to input a transfer clock for serial data from the CXP5034H. Serial data is latched on the rising edge of the transfer clock.
14	XLT	I	Terminal to input a latch signal from the CXP5034H. Latches a data (serial data from the CXP5034H) of 8-bit shift register to each register.
15	DATA	I	Serial data input from the CXP5034H.
16	XRST	I	System reset input. Reset is performed at "L" input.
17	CNIN	I	Tracking pulse input.
18	SENS	O	Outputs internal condition data for each address.
19	MUTG	I	Muting input. When the internal register ATTM is "L", MUTG sets the normal condition at "L" input, and the muted condition at "H" input.
23	SUBQ	O	Subcording Q data output.
24	SCOP	O	Subcording data sync S0 + S1 output.
25	SQCK	I/O	Subcording Q data readout clock input/output.
27	DOTX	I	Digital data output.
28	GFS	O	Frame sync locked condition indicating output.
29	DB08	I/O	External RAM data terminal. DATA8 (MSB)
30	DB07	I/O	External RAM data terminal. DATA7
31	DB06	I/O	External RAM data terminal. DATA6
32	DB05	I/O	External RAM data terminal. DATA5
33	VDD	—	Positive supply voltage.
34	DB04	I/O	External RAM data terminal. DATA4
35	DB03	I/O	External RAM data terminal. DATA3
36	DB02	I/O	External RAM data terminal. DATA2
37	DB01	I/O	External RAM data terminal. DATA1 (LSB)
38	RA01	I/O	External RAM address output. ADDR01 (LSB)
39	RA02	I/O	External RAM address output. ADDR02
40	RA03	I/O	External RAM address output. ADDR03
41	RA04	I/O	External RAM address output. ADDR04
42	RA05	I/O	External RAM address output. ADDR05
43	RA06	I/O	External RAM address output. ADDR06
44	RA07	I/O	External RAM address output. ADDR07
45	RA08	I/O	External RAM address output. ADDR08

Pin No.	Pin Name	I/O	Description
46	RA09	I/O	External RAM address output. ADDR09
47	RA10	I/O	External RAM address output. ADDR10
48	RA11	O	External RAM address output. ADDR11
49	RAWWE	O	Write enable signal output to the external RAM (active at "L").
50	RACS	O	Chip select signal output to the external RAM (active at "L").
51	C4M	O	X'tal division output. $f=4.2336$ MHz.
52	VSS	—	Ground (0V).
53	XTAI	I	X'tal oscillator circuit input. $f=8.4672$ MHz or 16.9344 MHz, depending on the selected mode.
54	XTAO	O	X'tal oscillator circuit input. $f=8.4672$ MHz or 16.9344 MHz, depending on the selected mode.
55	MD1	I	Mode selection input 1.
56	MD2	I	Mode selection input 2.
57	MD3	I	Mode selection input 3.
58	SLOB	I	Terminal to input a switching signal for audio data output cord. Serial data output at "H". Parallel data output at "L".
59	PSSL	I	Audio data output mode switching input serial output at "L", and parallel output at "H".
62	DA01	O	Outputs DA01 (parallel audio data, LSB) when PSSL="H", and C1F1 <sup>1</sup> when PSSL="L".
63	DA02	O	Outputs DA02 when PSSL="H", and C1F2 <sup>1</sup> when PSSL="L".
70	DA09	O	Outputs DA09 when PSSL="H", and PLCK <sup>2</sup> when PSSL="L".
71	DA10	O	Outputs DA10 when PSSL="H", and UGFS <sup>3</sup> when PSSL="L".
72	DA11	O	Outputs DA11 when PSSL="H", and GTOP <sup>4</sup> when PSSL="L".
73	VDD	—	Positive supply voltage: +5 V.
74	DA12	O	Outputs DA12 when PSSL="H", and RAOV <sup>5</sup> when PSSL="L".
75	DA13	O	Outputs DA13 when PSSL="H", and C4LR <sup>6</sup> when PSSL="L".
76	DA14	O	Outputs DA14 when PSSL="H", and C21O <sup>7</sup> when PSSL="L".
77	DA15	O	Outputs DA15 when PSSL="H", and C21O <sup>8</sup> when PSSL="L".
78	DA16	O	Outputs DA16 (parallel audio data MSB) when PSSL="H", and DATA <sup>9</sup> when PSSL="L".
79	WDCK	O	Strobe signal output. 176.4 kHz at DF ON, 88.2 kHz at DF OFF.
80	LRCK	O	Strobe signal output. 88.2 kHz at DF ON, and 44.1 kHz at DF OFF.

- \*NOTES: 1. C1F1: C1 decoding error correction condition data monitoring output.  
 C1F2: VCO/2 output.  $f=4.3218$  MHz when locked to the FFM signal.  
 2. PLCK: Unprotected frame sync pattern output.  
 3. UGFS: Frame synchronization protected condition indication output.  
 4. GTOP:  $\pm 4$ -frame jitter absorbing RAM overflow/under flow indicating output.  
 5. RAOV: Strobe signal. 352.8 kHz at DF ON, 176.4 kHz at DF OFF.  
 6. C4LR: C210 inverting output.  
 7. C21O: Bit clock output 4.2336 MHz at DF ON, 2.1168 MHz at DF OFF.  
 8. C210: Audio signal serial data output.

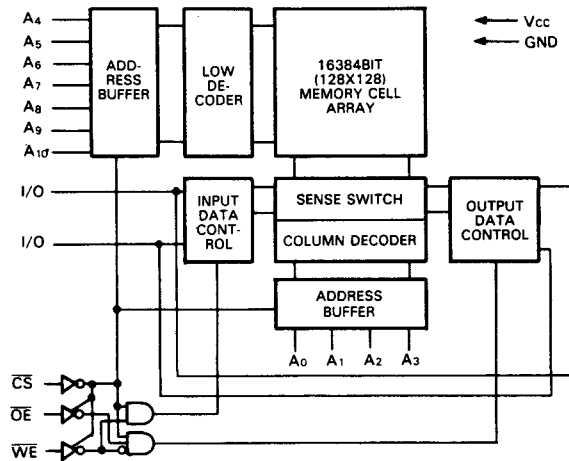
•SM5807 (Digital Filter)



◆ Terminal Function < SM5807 >

Pin No.	Pin Name	I/O	Description
1	X <sub>T</sub>	I	Clock input from crystal circuit.
2	X̄ <sub>T</sub>	O	Clock output.
3	CKSL	I	16.9344 (or 17.2872) MHz/ 8.4672 (or 8.6436) MHz select signal input. When CKSL is HIGH: Clock (16.9344 or 17.2872 MHz) is inputted to X <sub>T</sub> Terminal. When CKSL is LOW: Clock (8.4672 or 8.6436 MHz) is inputted to X <sub>T</sub> Terminal.
4	CKO	O	Clock output.
5	LRCI	I	Clock (44.1 kHz) input.
6	DIN	I	Serial data input. Serial data is valid on the rising edge of the serial bit clock (BCLK).
7	BCKI	i	Serial bit clock input.
8	V <sub>SS</sub>	—	Ground
9	SCSL	I	SCSL = "H": System clock = 192fs SCSL = "L": System clock = 196fs (fs = Sampling frequency)
10	DGR	O	Right channel deglitch signal (176.4 kHz) output.
11	DGL	O	Left channel deglitch signal (176.4 kHz) output.
12	DOUT	O	Serial data output. Left and right channel serial data is outputted alternately. The serial data is valid on the rising edge of the output bit clock (BCKO).
13	WDCO	O	Output data control (352.8 kHz) output.
14	LRCO	O	Output data control clock (176.4 kHz) output.
15	BCKO	O	Serial bit clock output. Typical frequency = 8.4672 or 8.6436 kHz. BCKO = 8.4672 kHz: SCSL is HIGH or Open ....System clock = 192fs BCKO = 8.6436 kHz: SCSL is LOW ....System clock = 196fs
16	V <sub>DD</sub>	—	Positive supply voltage: +5V.

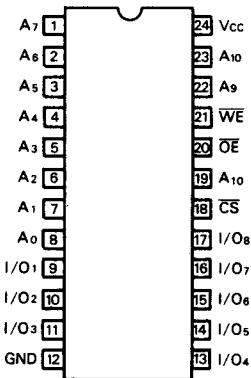
•TC5517AP/MSM5128/CXK5816/μPD446C  
(2048 Word x 8 bit Static RAM)



◆ Action Mode

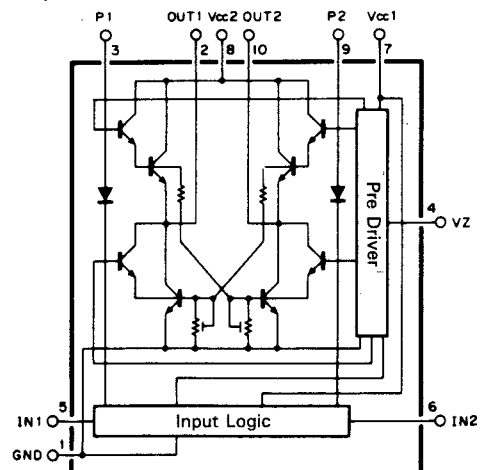
CS	OE	WE	CHIP	OUTPUT MODE	CURRENT
H	X	X	Non Select	High Impedance	I <sub>CCS</sub>
L	H	H	Read	DOUT	I <sub>CCA</sub>
L	L	H	Write	DIN	

H: High Level  
L: Low Level  
X: High or Low Level



A<sub>0</sub> - A<sub>10</sub>: Address Input  
I/O<sub>1</sub> - I/O<sub>8</sub>: Data Input  
CS: Chip Select Input  
WE: Write Enable Input  
OE: Output Enable Input  
V<sub>CC</sub>: +5V Power Supply  
GND: Ground

•LB1461 (Motor Drive)





•M50747 (System Control)

◆ Terminal Function

Pin No.	Pin Name	I/O	Description
1	Vcc	—	Positive supply voltage: +5V.
3	CE	O	Terminal to output a chip enable signal for serial data to the CXP5014.
4	PKO	O	Terminal to output a feed-kick signal in POWER ON mode.
10	STB1	I	Terminal to input a timing signal for parallel data from the CXP5014.
11	SSTB	O	Terminal to output a timing signal for serial data to the CXP5034.
13	ACK2	O	Terminal to output a response signal for parallel data to the CXP5034.
14~17	IDAT3~IDATO	I	Terminal to input a key switch and remote controller data from the CXP5014.
19	CLK	O	Terminal to output a clock for serial data to the CXP5014.
20	SDATA	O	Serial data output to the CXP5014.
26	QINT	I	Terminal to input an interrupting signal from the CXP5034.
27	CNVss	—	0V
28	RESET	I	Terminal for inputting a reset signal.
29	EXTAL	I	System clock input: Typical frequency = 4.2336 MHz.
32	Vss	—	Ground
33	SACK	I	Terminal to input a response signal for serial data from the CXP5014.
34	TEST1	I	Test input; not used in normal operation.
35	TEST2	I	Test input; not used in normal operation.
40	SHE	I	Terminal to input a signal for high-speed access mode from the CXP5034H.
41	MACK	I	Terminal to input a response signal for parallel data from the CXP5034H.
42	MSTB	I	Terminal to input a strobe signal for parallel data from the CXP5034H.
43	SREQ	O	Terminal to output a timing signal for parallel data to the CXP5034H.
44	SACK	O	Terminal to output a response signal for parallel data to the CXP5034H.
45~48	D3~D0	I/O	Data bus lines from/to the CXP5034H.
59	TIMER1	I	This terminal is used for inputting a signal for TIMER operation.
62	SSTOP	I	Terminal for inputting a signal from lead-in switch.
63	TRAY-IN	I	Terminal for inputting a signal from loading-in switch.
64	TRAY-OUT	I	Terminal for inputting a signal from loading-out switch.

•CXP5034H (Mechanism Control)

◆ Terminal Function

Pin No.	Pin Name	I/O	Description
1	SQCK	I	Terminal to input a clock for subcoding Q-channel signal for the CXD1125.
4	SUBQ	O	Subcoding Q-channel signal input from the CXD1125.
5	TRAY OUT	I	Disc tray out (loading out) switch input.
6	TRAY IN	I	Disc tray in (loading in) switch input.
7	S STOP	I	Lead-in switch signal input.
8	CHANGER	I	Terminal for selecting single and changer. This terminal is fixed at "L" level usually.
9~12	D0~D3	I/O	Data bus lines from/to the MSM50747.
13	SACK	I	Terminal to input a response signal for parallel data from the MSM50747.
14	SREQ	I	Terminal to input a timing signal for parallel data from the M50747.
15	QINT	O	Terminal to output an interrupting signal to the M50747.
16	MSTB	O	Terminal to output a timing signal for parallel data to the M50747.
17	MACK	O	Terminal to output a response signal for parallel data to the MSM50747.
18	SHE	O	Terminal to output a signal for high-speed access mode to the MSM50747. High-speed access mode is set at "H" level.
20	TCTC	I	Terminal to input a count signal for track number of disc.
21	Vss	—	Ground.
22	FOK	I	Terminal to input a signal for focus servo OK. Focus servo OK mode in "H" level.
23	GFS	I	Terminal to input a signal for frame sync locked condition from the CXD1125.
24	SENS	I	Terminal to input a condition signal from the CXA1082 and CXD1125.
26	MUTG	O	Terminal to output a muting signal. In muting, this terminal becomes an "H" level.
27	DATA	O	Terminal to output a serial data to the CXA1082 and CXD1125.
28	XLT	O	Terminal to output a latch signal for serial data to the CXA1082 and CXD1125.
29	CLK	O	Terminal to output a clock for serial data to the CXA1082 and CXD1125.
30	LDON	O	Terminal to output a signal for the laser diode ON.
31	XRST	O	Terminal to output a reset signal to the CXA1082 and CXD1125.
32	DE	O	Terminal to output a driving signal for deemphasis circuit. Active "H".
35	EXTAL	I	System clock input, typical frequency = 4.2336 MHz.
36	RESET	I	Terminal for inputting a reset signal.
37	SCOR	I	Terminal to input a subcoding sync S0+S1 from the CXD1125.
38, 39	TRAY+ TRAY-	O	Terminal to output a signal for loading motor drive.
42	VDD	—	Positive supply voltage: +5V.

•CXP5014 (Display Control)

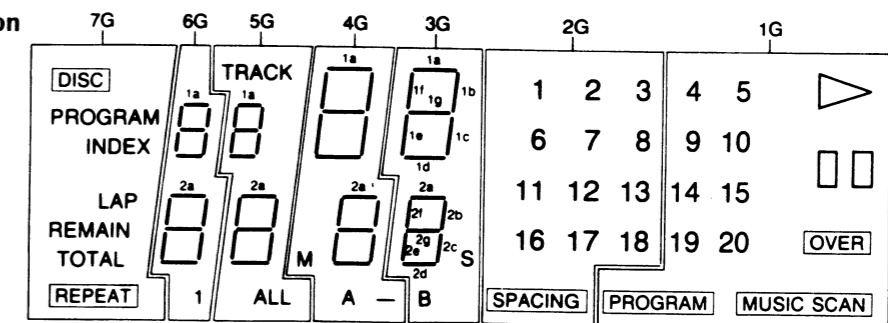
◆ Terminal Function

Pin No.	Pin Name	I/O	Description
3	RMC	I	Remote controller signal input.
4	CLK	I	Serial data clock input from the M50747.
7	SDATA	I	Serial data input from the M50747.
8	SACK2	O	Terminal to output a response signal for receiving serial data to the M50747.
12~15	PC0~PC3	O	Terminals for outputting a key return signal to externally connected key matrix.
16~19, 20~23	PE0~PE3, RMD0~RMD3	I	Terminals for inputting a key return signal from externally connected key matrix.
28	SSTB	I	Terminal to input a timing signal for receiving serial data from the M50747.
29	CE	I	Terminal to input a chip enable signal for receiving serial data from the M50747.

Pin No.	Pin Name	I/O	Description
30	STB1	O	Terminal to output a timing signal for parallel data from the M50747.
31	ACK2	I	Terminal to input a response signal for parallel data from the M50747.
32	Vss	—	Ground
33~48	a~p	O	Terminals for Outputting segment signals to FL display.
50~56	7G~1G	O	Terminals for outputting grid signals to FL display.
57	VfDP	—	Terminal for connecting a supply voltage to filament of FL display.
59	QINT	I	Terminal to input a chip enable signal for serial data from the M50747.
61	EXTAL	I	System clock input, typical frequency = 4.2336 MHz.
62	RESET	I	Terminal for inputting a reset signal.
64	VDD	—	Positive supply voltage: +5V.

3. DESCRIPTION OF FV170G FL DISPLAY

•Grid Configuration



•Anode Configuration

	7G	6G	5G	4G	3G	2G	1G
a	DISC	1a	1a	1a	1a	1	4
b	PROGRAM	1b	1b	1b	1b	2	5
c	—	1c	1c	1c	1c	6	9
d	—	1d	1d	1d	1d	8	10
e	—	1e	1e	1e	1e	7	10
f	INDEX	1f	1f	1f	1f	3	▷
g	—	1g	1g	1g	1g	—	—
h	—	—	TRACK	M	S	—	—
i	LAP	2a	2a	2a	2a	11	14
j	RAMAIN	2b	2b	2b	2b	12	15
k	—	2c	2c	2c	2c	16	19
l	—	2d	2d	2d	2d	18	MUSIC SACN
m	—	2e	2e	2e	2e	17	20
n	TOTAL	2f	2f	2f	2f	13	OVER
o	REPEAT	2g	2g	2g	2g	—	—
p	—	1	ALL	A-	B	SPACING	PROGRAM

•Pin Configuration

PIN NO.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	33	34	35	36	37	38	39	40	41	42		
CONNECTION	F	F	N	P	P	I	M	K	N	P	O	N	J	I	N	H	D	E	C	N	P	G	F	B	A	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N

### 4. ADJUSTMENTS

Note: 1) Required test disc CD-1 of EIAJ.  
 2) Test pins and adjustment parts are shown in Figs. 4-1 and 4-2.

STEP	SUBJECT	MEASURE OUTPUT	ADJUST. PARTS	ADJUSTMENT	SETTING CONDITIONS AND REMARKS
1	VCO Temporary Adj. (STOP mode)	Test Pin TP (VCO) on the F-5939 board. Frequency Counter	fVR5 (F-5931)	4.32 MHz ± 30 kHz	1. Connect TP (EFM) to ground on the F-5931 board. 2. For this adjustment run the unit for more than one minute after the power is switched ON.
2	Tracking Offset Adj.	Test Pin TP (T1) on the F-5931 board. Oscilloscope	fVR1 (F-5931)	• Oscilloscope: DC range  Fig. 1 • Adjust fVR1 to satisfy as shown in Fig. 1.	1. Connect TP (T2) to ground on the F-5931 board. 2. Play the 8th music on the TESTDISC CD-1. 3. Connect a probe of oscilloscope to TP (T1) during PLAY mode.
3	FOCUS Offset Adj.	Test Pin TP (T2) on the F-5931 board. Oscilloscope	fVR2 (F-5931)	• Oscilloscope: DC range  Fig. 2 • Make eye-pattern waveform best. (Widen center portion (◇) of waveform sufficiently and symmetrically.)	1. Play the 8th music on the TEST DISC CD-1. 2. Connect a probe of oscilloscope to TP (T2) during PLAY mode.
4	Tracking Gain Adj.		fVR3 (F-5931)	 Fig. 3 • Set the end of groove of fVR3 to the direction of arrow A as shown in Fig. 3	
5	Focus Gain Adj.		fVR4 (F-5931)	 Fig. 4 • Set the end of groove of fVR4 to the direction of arrow B as shown in Fig. 4.	
6	VCO Adj. (STOP mode)	Test Pin TP (VCO) on the F-5939 board. Oscilloscope	fVR5 (F-5931)	4.250 MHz ± 1kHz	• Connect TP (EFM) to ground on the F-5931 board.
7	Distortion Adj.	LINE OUT Terminal. Oscilloscope and Distortion Meter	vVR1L and vVR1R (F-5931)	Minimum distortion.	1. Play first music of the TEST DISC CD-1. 2. Check of both left channel and right channel.

Fig. 4-1 F-5939

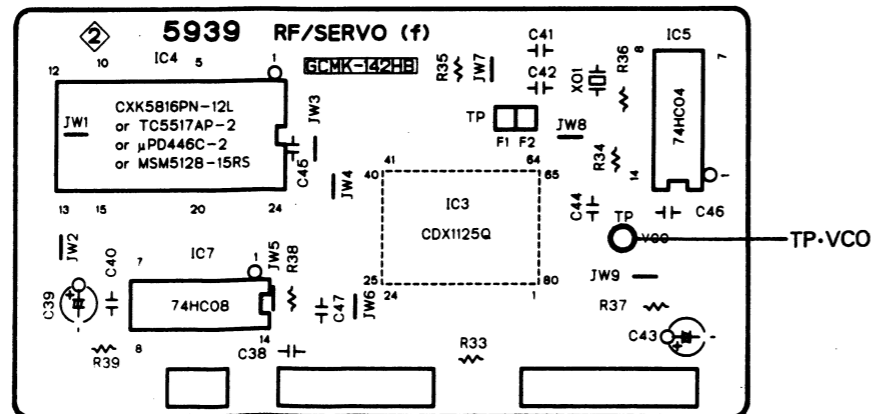
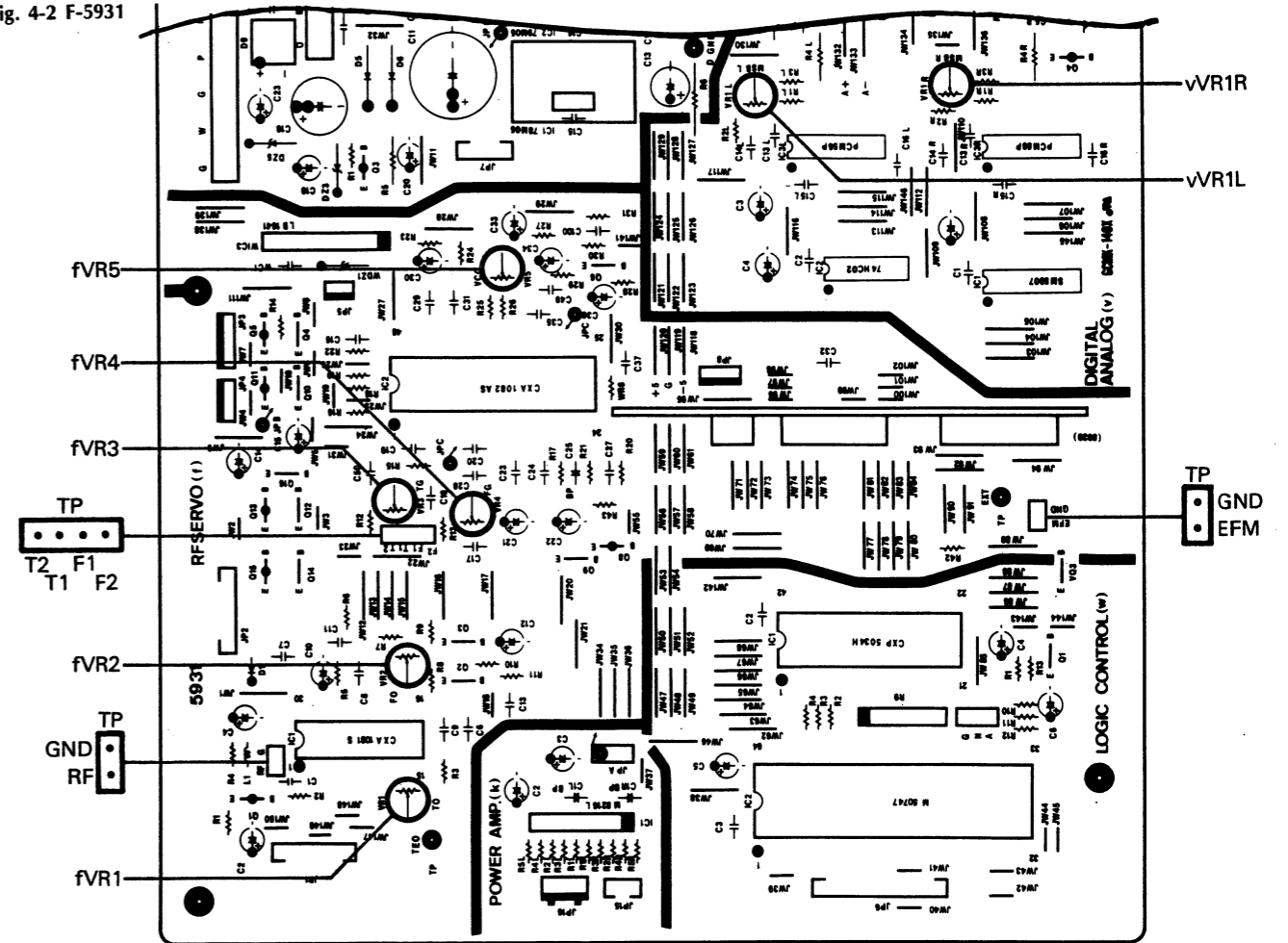


Fig. 4-2 F-5931



### 5. EXPLODED VIEW OF MECHANISM ASS'Y AND PARTS LIST

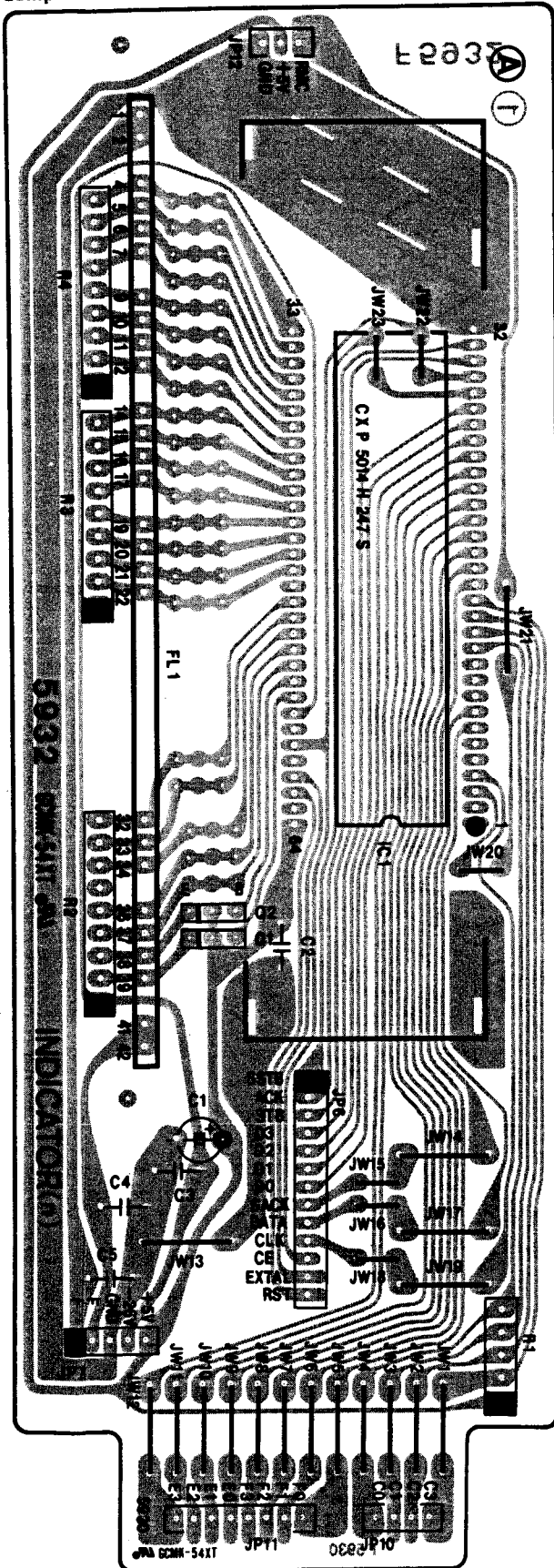
Parts List <CD Mechanism Ass'y>

Parts No.	Stock No.	Description	Parts No.	Stock No.	Description
1	18178700	Clamp Arm Ass'y	25	27379410	Spacer
1-1	27365600	Clamp Cover	26	27365000	Sled Gear B
1-2	27365700	Clamp Plate	27	48574400	Loading IN Detector Switch
1-3	27365800	Clamp Arm	28	48794000	Sled IN Detector Switch
1-4	27365410	Thrust Plate	29	48829000	Loading OUT Detector Switch
1-5	27279100	Steel Ball	30	18159300	Sled Motor Ass'y (with Worm Gear)
1-6	27423200	Cushion Sheet			
2	18176101	Disc Tray Ass'y	31	27366600	Motor Band
2-1	27538100	Disc Tray	32	48584900	Spindle Motor
2-2	27423400	Right Lifter Ass'y	33	27593500	Clamp Arm Spring
2-3	27423300	Left Lifter Ass'y	34	27463700	Arm Stopper
2-4	27364800	Lifter Spring	35	47420900	Lock Pin
3	27553900	Disc Tray Panel			
9	27279100	Steel Ball	S1	46319800	M3x8 Bind Head Deltite Screw
10	48830500	Pick-up Ass'y	S2	46268000	M3x8 Franged Head Deltite Screw
11	27363800	Support Rail	S3	13122300	M3x6 Bind Head Machine Screw
12	27364500	Spring Damper	S4	18158700	M3x8 Bind Head Screw
13	27367000	Cam Gear	S5	46609800	M2x3 Bind Head Machine Screw
14	27364000	Drive Gear	S6	49198900	M2.6x6 Washer Head Tapping Screw
15	27365200	Loading Gear			
16	27422600	Loading Pulley	S7	00421300	M2.6x6 Bind Head Screw
17	27422700	Belt	S8	13301100	M2x8 Bind Head Tapping Screw
18	27364700	Switch Arm	S9	51625200	M3x10 Washer Head Tapping Screw
19	27537600	Turn Table Ass'y			
20	27462120	CD Holder	S10	18154800	M2x4 Pan Head Machine Screw
21	27364910	Sled Gear A			
22	27364400	Floating Rubber	W3	27364300	2.5φ Slit Washer
23	18159100	Loading Motor Ass'y (with Pulley)	W4	27364600	6.6φ Thrust Washer
24	27365500	Plate Spring	W5	27537500	Silicon Washer

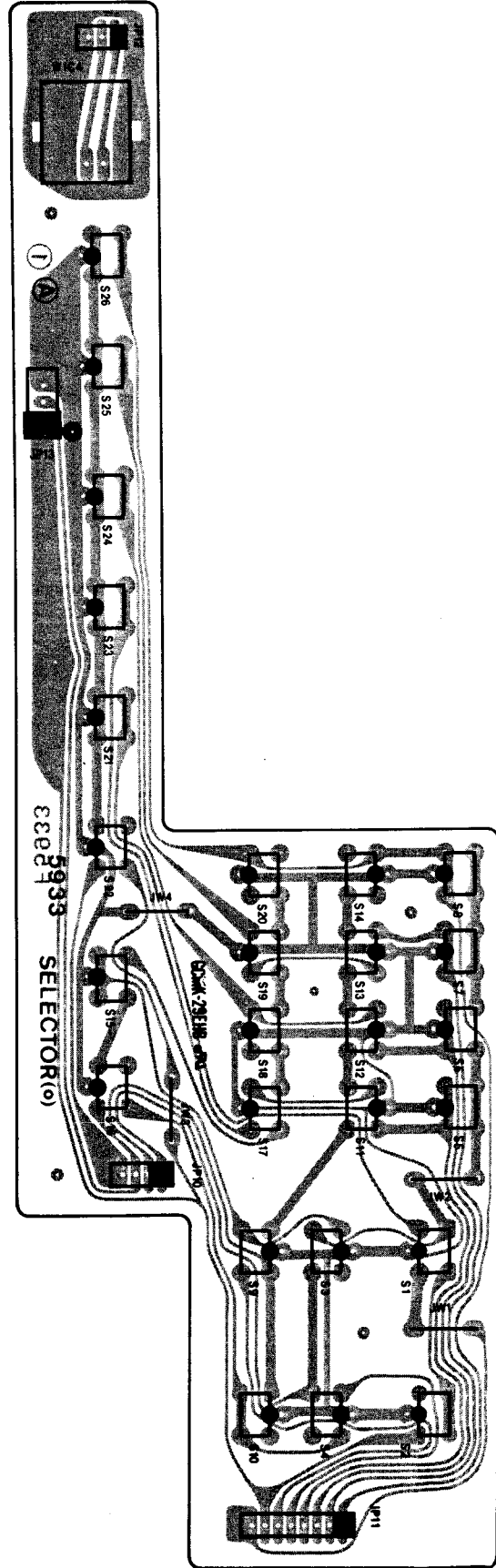


## 6. PARTS LOCATION ON BOARD

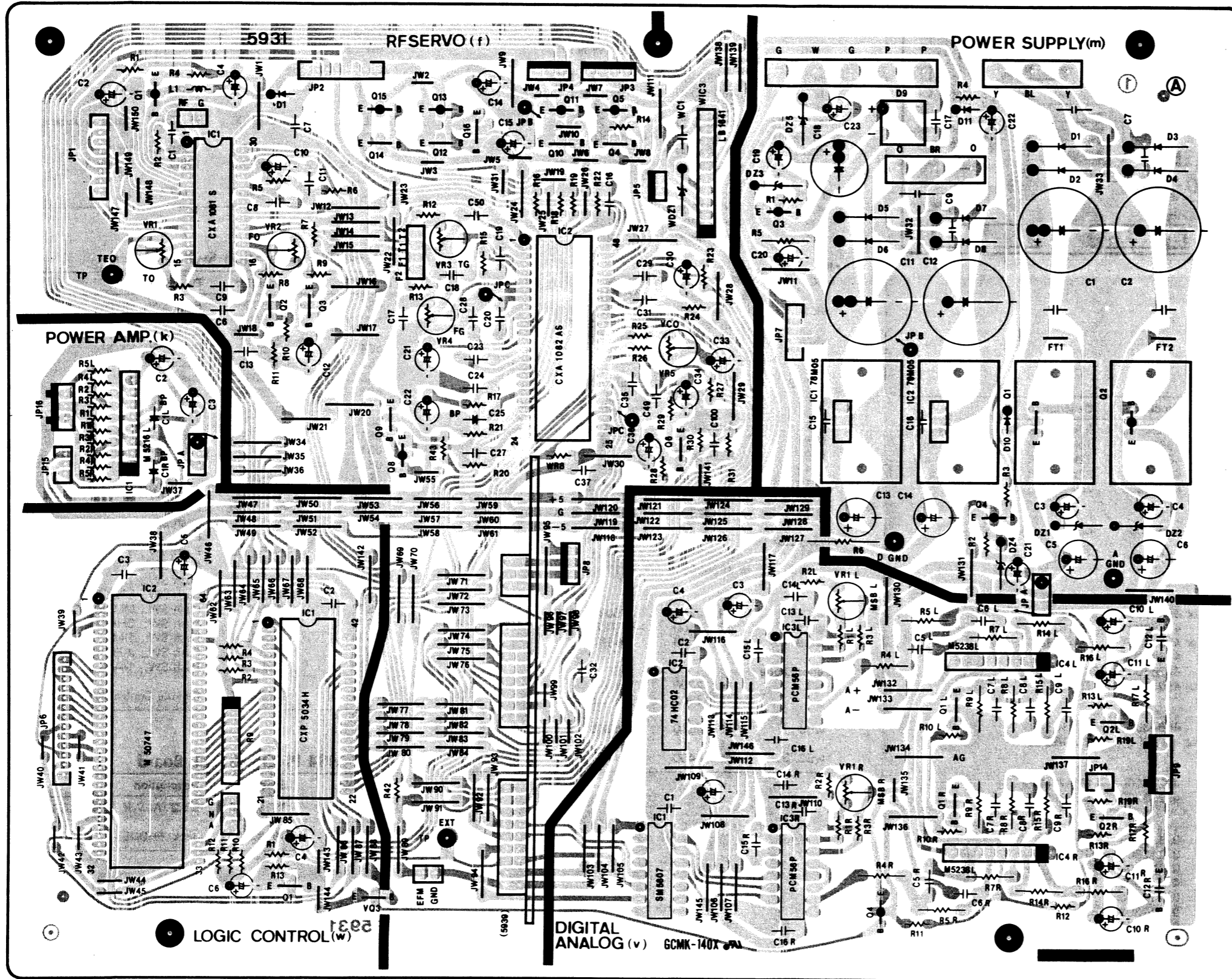
6-1. F-5932 FL Display Tube Board  
Component Side



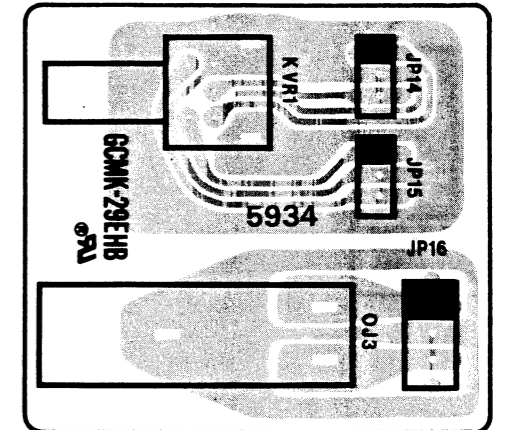
6-2. F-5933 Operation Switch Board  
Component Side



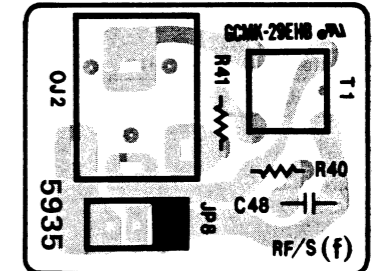
6-3. F-5931 Main Board  
Component Side



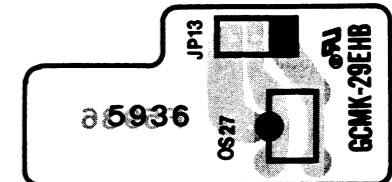
6-4. F-5934 PHONES Jack Board  
Component Side



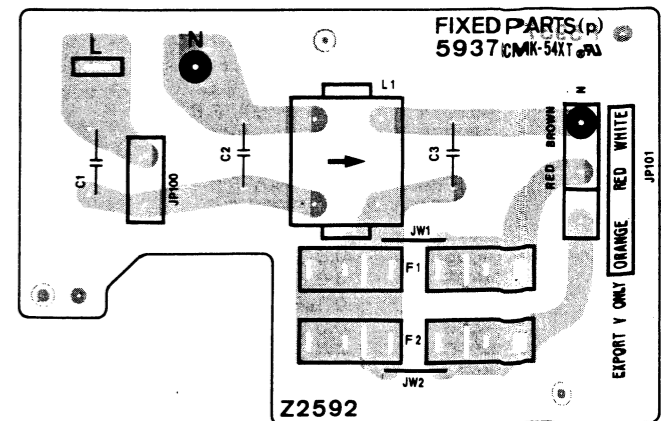
6-5. F-5935 DIGITAL OUT Terminal Board  
Component Side



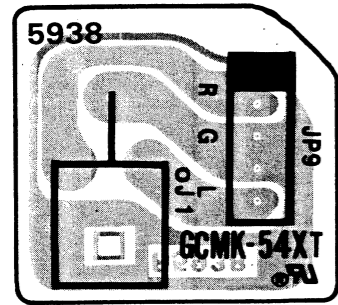
6-6. F-5936 OPEN/CLOSE Switch Board  
Component Side



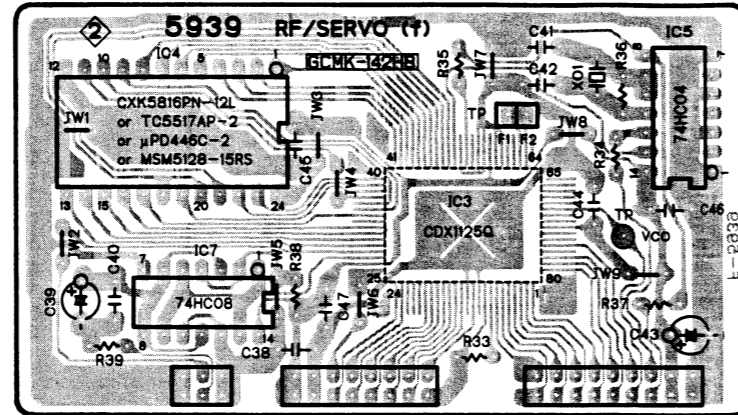
6-7. F-5937 Line Filter Board  
Component Side



6-8. F-5938 LINE OUT Terminal Board  
Component Side



6-9. F-5939 Digital Signal Processing Board  
Component Side



## 7. PARTS LIST OF BOARD

7-1. F-5931 Main Board <Stock No. 01098601>

Parts No.	Stock No.	Description
<b>•Transistor</b>		
fQ1	46359701	2SA952
fQ2, 3	46367101	2SC2603
	or 48058801	2SC1740S
fQ4	46359801	2SC2001
fQ5	46359701	2SA952
fQ6	48916900	DTC114YF
fQ8	46719800	DTA124ES
fQ9	46719900	DTC124ES
fQ10	46359801	2SC2001
fQ11	46359701	2SA952
fQ12	46359801	2SC2001
fQ13	46359701	2SA952
fQ14	46359801	2SC2001
fQ15	46359701	2SA952
<b>•IC</b>		
fIC1	48839900	CXA1081S
fIC2	48840000	CXA1082AS
<b>•Diode</b>		
fD1	46464100	1SS133
fR25	48438400	3.3kΩ 1/5W M.R.
fR30, 31	48442000	100kΩ 1/5W M.R.
fC6	48087200	0.033μF 50V F.C.
fC8, 9	48086000	0.01μF 50V F.C.
fC14, 15	48832000	470μF 16V E.C.
fC17, 18	49201400	4700pF 50V F.C.
fC19	48087600	0.047μF 50V F.C.
fC20	48088400	0.1μF 50V F.C.
fC23	48088400	0.1μF 50V F.C.
fC24	48748400	0.1μF 50V C.C.
fC25	48103000	0.22μF 50V E.B.
fC27	48086000	0.01μF 50V F.C.
fC28	48087200	0.033μF 50V F.C.
fC29	48748400	0.1μF 50V C.C.
fC31	48087200	0.033μF 50V F.C.
fC35	49201400	4700pF 50V F.C.
fC37	48748400	0.1μF 50V C.C.
fC50	48748400	0.1μF 50V C.C.
fC101	48748400	0.1μF 50V C.C.
fL1	48289400	10μH Inductor

Parts No.	Stock No.	Description
fVR1	46634500	22kΩ S.V.R., Tracking Offset adj.
fVR2	46634300	10kΩ S.V.R., Focus Offset adj.
fVR3	46634500	22kΩ S.V.R., Tracking Gain adj.
fVR4	46634500	22kΩ S.V.R., Focus Gain adj.
fVR5	48118800	2kΩ S.V.R., VCO adj.
<b>•IC</b>		
kIC1	48577000	M5216L
kC1	48102000	10μF 16V E.B.
<b>•Transistor</b>		
ΔmQ1	48150101	2SD1406
	or 48508801	2SC3851
ΔmQ2	48150801	2SB1015
	or 48509101	2SA1488
ΔmQ3	46614001	2SA1283
mQ4	46367001	2SA1115
	or 48058601	2SA933S
<b>•FET</b>		
mFT1, 2	46643502	2SK163-L1
	or 46643503	2SK163-L2
<b>•IC</b>		
ΔmIC1	49232100	M5F78M05L
ΔmIC2	49233200	M5F79M05L
<b>•Diode</b>		
ΔmD1	07112300	10DF2
ΔmD2	07112300	10DF2
ΔmD3	07112300	10DF2
ΔmD4	07112300	10DF2
ΔmD5	07112300	10DF2
ΔmD6	07112300	10DF2
ΔmD7	07112300	10DF2
ΔmD8	07112300	10DF2
ΔmD9	46273600	DBB10B
mD10, 11	46464100	1SS133
<b>•Zener Diode</b>		
mDZ1, 2	46112900	05Z9.1-X
	or 46113000	05Z9.1-Y
mDZ3	46116200	05Z27-X
mDZ4	46112300	05Z7.5-X
	or 46112400	05Z7.5-Y

<F-5931>

Parts No.	Stock No.	Description
mDZ5	03168300	RD4.7F
mR6	46624700	220Ω 2W N.I.R.
mC7	48086000	0.01μF 50V F.C.
mC9	48086000	0.01μF 50V F.C.
mC11, 12	49265600	3300μF 16V E.C.
mC13, 14	48832000	470μF 16V E.C.
mC15, 16	48748400	0.1μF 50V C.C.
mC17	48747200	0.01μF 50V F.C.
mC18	49266000	470μF 50V E.C.
<b>•Transistor</b>		
vQ1, 2	46604301	2SC3327
vQ3	46719900	DTC124ES
vQ4	46719800	DTA124ES
<b>•IC</b>		
vIC1	48984900	SM5807BP
	or 48984910	SM5807EP
vIC2	48319700	TC74HC02P
	or 49265100	TC74HC02AP
vIC3	48666800	PCM56P
vIC4	48730400	M5238L
vC1, 2	48748400	0.1μF 50V C.C.
vC5	49200600	2200pF 50V F.C.
vC6	49200000	1200pF 50V F.C.
vC7	49200400	1800pF 50V F.C.
vC8	48086400	0.015μF 50V F.C.
vC9	49247500	270pF 50V F.C.
vC12	48086000	0.01μF 50V F.C.
vC13~16	48748400	0.1μF 50V C.C.
vVR1	46634900	100kΩ S.V.R., Distortion adj.
<b>•Transistor</b>		
wQ1	46367101	2SC2603
	or 48058801	2SC1740S
<b>•IC</b>		
wIC1	49260900	CXP5034H-062S
wIC2	49250400	M50747-656SP
wIC3	48982600	LB1641
<b>•Zener Diode</b>		
wDZ1	46112700	05Z8.2-Y
	or 46112800	05Z8.2-Z
wR9	48774800	100kΩX8 A.R.
wC2, 3	48748400	0.1μF 50V C.C.

7-2. F-5932 FL Display Tube Board

<Stock No. 01098701>

Parts No.	Stock No.	Description
<b>•Transistor</b>		
nQ1, 2	48916900	DTC114YF
<b>•IC</b>		
nIC1	49235600	CXP5014-247S
nFL1	48903700	VF170G FL. Display Tube
nR1	46341900	10kΩX4 1/8W A.R.
nR2~4	46350500	100kΩX8 1/8W A.R.
nC2~5	48748400	0.1μF 50V C.C.

7-3. F-5933 Operation Switch Board

Parts No.	Stock No.	Description
oS1	49250300	Push SW., PLAY
oS2	49250300	Push SW., PAUSE
oS3	49250300	Push SW., RANDOM
oS4	49250300	Push SW., STOP
oS5	49250300	Push SW., 0
oS6	49250300	Push SW., 3
oS7	49250300	Push SW., 2
oS8	49250300	Push SW., 1
oS9	49250300	Push SW., <<
oS10	49250300	Push SW., >>
oS11	49250300	Push SW., SET
oS12	49250300	Push SW., 6
oS13	49250300	Push SW., 5
oS14	49250300	Push SW., 4
oS15	49250300	Push SW., <<<
oS16	49250300	Push SW., >>>
oS17	49250300	Push SW., CL
oS18	49250300	Push SW., 9
oS19	49250300	Push SW., 8
oS20	49250300	Push SW., 7
oS21	49250300	Push SW., SPACING
oS22	49250300	Push SW., MUSIC SCAN
oS23	49250300	Push SW., CHECK
oS24	49250300	Push SW., TIME
oS25	49250300	Push SW., A-B
oS26	49250300	Push SW., 1/ALL
wIC4	48525000	Remote Control Receiver BX1407

7-4. F-5934 PHONES Jack Board

Parts No.	Stock No.	Description
kVR1	49197300	50kΩ (A) V.R., PHONES LEVEL
oJ3	49197600	Jack, PHONES

7-5. F-5935 DIGITAL OUT Terminal Board

Parts No.	Stock No.	Description
fT1	49197000	Pulse Transformer
oJ2	49197500	1P Pin Terminal, DIGITAL OUT

7-6. F-5936 OPEN/CLOSE Switch Board

Parts No.	Stock No.	Description
oS27	48306900	Push SW., OPEN/CLOSE

7-7. F-5937 Line Filter Board

Parts No.	Stock No.	Description
Δ pC1	46943200	0.01μF 400V C.C.
Δ pC2	46426500	3300pF 400V C.C.
Δ pC3	46943200	0.01μF 400V C.C.
Δ pL1	49197100	Line Filter

7-8. F-5938 LINE OUT Terminal Board

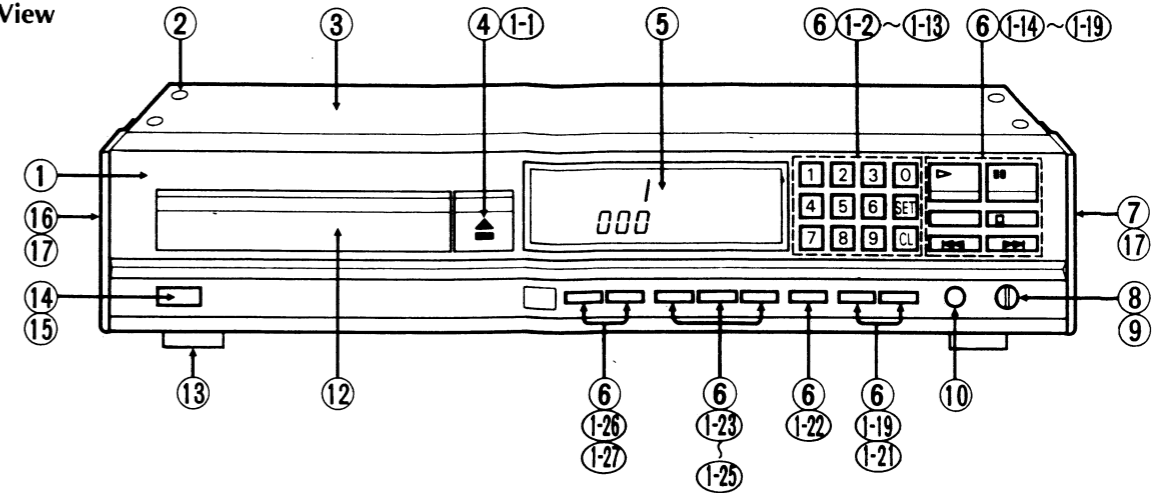
Parts No.	Stock No.	Description
oJ1	48792100	2P Pin Jack, LINE OUT

7-9. F-5939 Digital Signal Processing Board

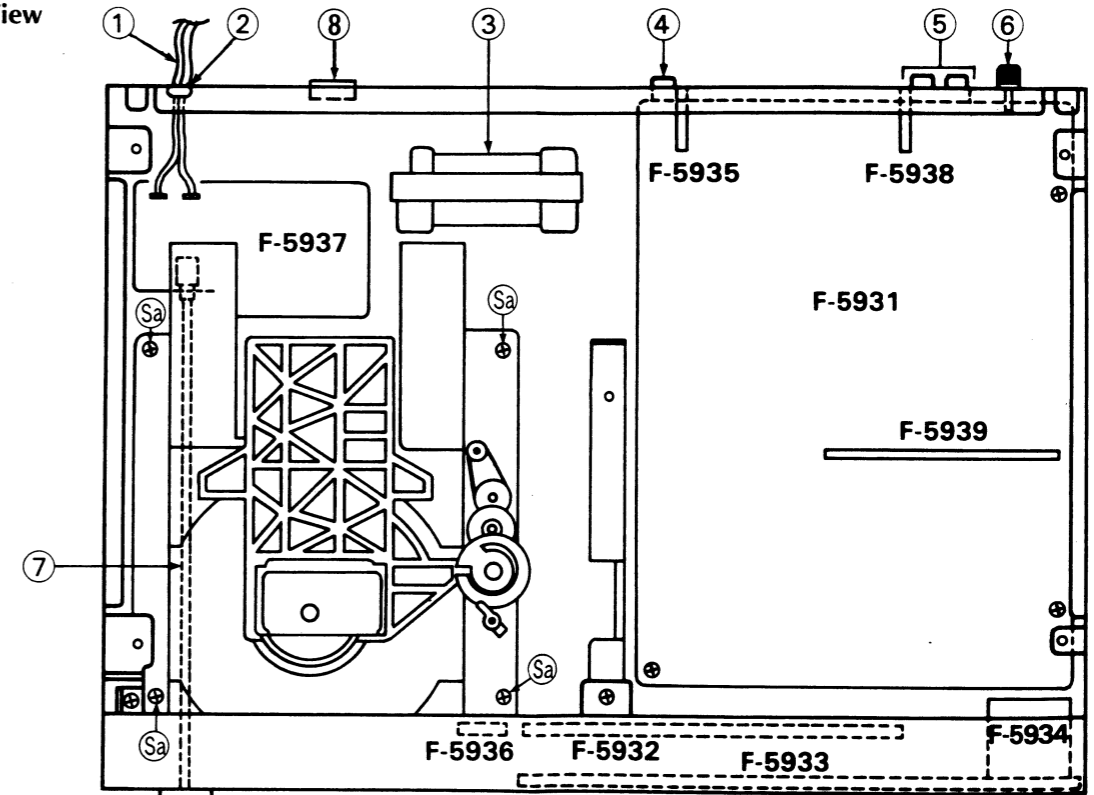
<Stock No. 01099401>

Parts No.	Stock No.	Description
•IC		
fIC3	48976700	CXD1125Q-Z
fIC4	48718000	TC5517AP-2
	or 48718100	μPD446C-2
	or 48718300	MSM5128-15RS
	or 48839700	CXK5816PN-12L
	or 49260400	CXK5816PN-15L
	or 49260500	CXK5816PS-12L
	or 49260600	CXK5816PS-15L
fIC5	48423400	TC74HC04P
	or 48723600	μPD74HC04C
	or 49265200	TC74HC04AP
fIC7	48423500	TC74HC08P
	or 48723700	μPD74HC08C
	or 49265300	TC74HC08AP
fXO1	48592500	16.9344MHz Quartz Element
fC38	48748400	0.1μF 50V C.C.
fC40	48748400	0.1μF 50V C.C.
fC44~47	48748400	0.1μF 50V C.C.
fC102	48748400	0.1μF 50V C.C.

•Front View



•Top View



8. OTHER PARTS

Parts List <Front View>

Parts No.	Stock No.	Description
1	27555900	Front Panel Ass'y
1-1	27591700	OPEN/CLOSE•Knob
1-2	27419300	1•Knob
1-3	27419400	2•Knob
1-4	27419500	3•Knob
1-5	27419600	4•Knob
1-6	27419700	5•Knob
1-7	27419800	6•Knob
1-8	27419900	7•Knob
1-9	27420000	8•Knob
1-10	27420100	9•Knob
1-11	27420200	0•Knob
1-12	27549200	SET•Knob
1-13	27549300	CL•Knob
1-14	27547100	PLAY•Knob
1-15	27547200	PAUSE•Knob
1-16	27546500	RANDOM•Knob
1-17	27546600	STOP•Knob
1-18	27546700	◀•Knob, AMPS
1-19	27546800	▶•Knob, AMPS
1-20	27548900	◀•Knob, FR
1-21	27549000	▶•Knob, FF
1-22	27548800	MUSIC SCAN•Knob

Parts No.	Stock No.	Description
1-23	27548500	TIMER•Knob
1-24	27548600	CHECK•Knob
1-25	27548700	SPACING•Knob
1-26	27548300	1/ALL•Knob
1-27	27548400	A-B•Knob
2	27290910	BO Holder
3	27389300	Bonnet
4	48306900	Push SW., OPEN/CLOSE
5	48903700	VF170G FL Display
6	49250300	Push SW., Operation
7	27293110	Dress Side Panel Right
8	47639310	Knob, LEVEL (Phones)
9	49197300	50kΩ (A) V.R., Phones Level
10	48792100	Pin Jack, PHONES
12	27553900	Disc Tray Panel
13	47716600	Leg Ass'y
Δ 14	49197200	Push SW., POWER
15	27554100	Power Knob Ass'y (Included SW. Rod and SW. Joint)
16	27321910	Dress Side Panel Left
17	48719700	M5x10 H. Socket Head Screw, Dress Side Panel

Parts List <Top View>

Parts No.	Stock No.	Description
Δ 1	38004700	Power Supply Cord (XX)
Δ	48837700	Power Supply Cord (SS)
Δ	46321000	Power Supply Cord (UL-CSA)
Δ	38004500	Power Supply Cord (EU-SEV)
Δ	49252900	Power Supply Cord (UK)
2	39104900	Strain Relief (UL-CSA)
	39106000	Strain Relief (XX)
	48913500	Strain Relief (EU-UK-SEV-SS)
Δ 3	15031809	Power Transformer (XX-SS)
Δ	15031802	Power Transformer (UL-CSA)
Δ	15031805	Power Transformer (EU-UK-SEV)

Parts No.	Stock No.	Description
4	49197500	1P Pin Jack Terminal, DIGITAL OUT
5	48792100	2P Pin Jack Terminal, LINE OUT
6	48587600	GND Terminal
7	27570010	Rod Ass'y
Δ 8	48175200	Voltage Selector (XX)
Δ	07204700	Slide SW., Voltage Selector (EU-UK-SEV)





# 10. HOW TO REPLACE MAIN PARTS

(See Exploded View of Mechanism Ass'y on Page 9)

## A. Disc Tray Ass'y ① (See Fig. 10-1 and 10-2)

- 1) Remove the bonnet.
- 2) Turn the loading gear ⑮ clockwise until the clamp arm ass'y ① is fully up.
- 3) Grasp the disc tray with your hand and pull it forward until it is secured by the leaf switch holder (See Fig. 10-2).
- 4) Turn the leaf switch holder fully counterclockwise (in the direction of the arrow) (See Fig. 10-2).
- 5) Pull the disc tray out forward.

**Note:**

Be sure to set the leaf switch holder back in its original position after installing the disc tray.

Fig. 10-1

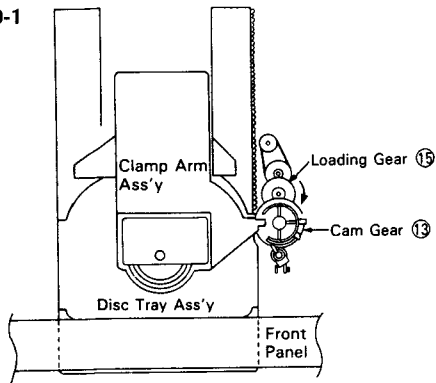


Fig. 10-2

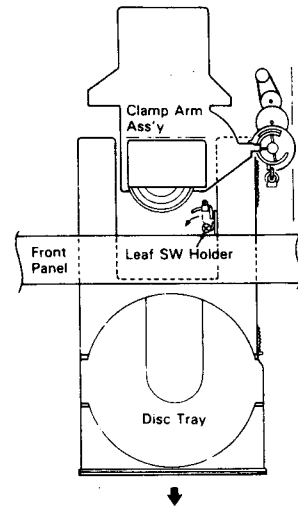
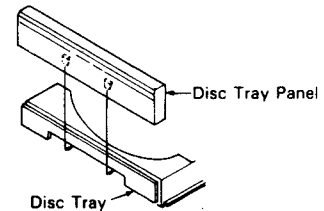


Fig. 10-3



## B. Disc Tray Panel ③

- 1) Pull the disc tray ass'y forward.
- 2) Take off the disc tray panel from the disc tray as shown in Fig. 10-3.

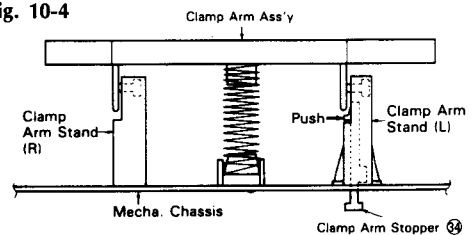
## C. Mechanism Ass'y

- 1) Remove the bonnet.
- 2) Remove the disc tray ass'y from mechanism ass'y.
- 3) Disconnect five lead wires connectors JP1, JP2, JP3, JP4 and JP5 from the F-5931 board.
- 4) Take out the mechanism ass'y from the unit.  
(Loosen four screws ⑤, see top view figure on page 12)

## D. Clamp Arm Ass'y ①

- 1) Take out the mechanism ass'y.
- 2) Push the clamp arm stopper ⑳ as shown in Fig. 10-4, and remove it from left side clamp arm stand.
- 3) Detach the clamp arm ass'y from clamp arm stand (See Fig. 10-4).

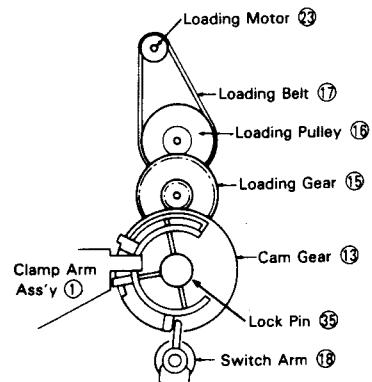
Fig. 10-4



## E. Loading Belt ⑰ (See Fig. 10-5)

- 1) Remove the disc tray ass'y from mechanism ass'y.
- 2) Remove the switch arm ⑱ from mechanism chassis.
- 3) Pull out the lock pin ㉔ from cam gear.
- 4) Remove the cam gear ⑬ and drive gear ⑭.
- 5) Remove the loading gear ⑮.
- 6) Remove the loading belt ⑰ from the loading pulley ⑯.
- 7) Remove the loading pulley.

Fig. 10-5



## F. Spindle Motor ㉒

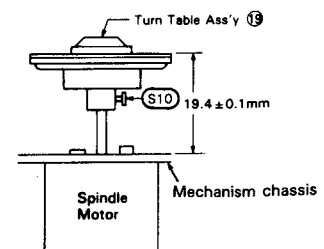
- 1) Remove the disc tray ass'y.
- 2) Take out the mechanism ass'y.
- 3) Remove the clamp arm ass'y from mechanism ass'y.
- 4) Detach the turntable ass'y ⑲ from the shaft of spindle motor.
- 5) Remove the two screws ㉕ fixing spindle motor.

**Note:**

Be sure to adjust the height whenever the spindle motor and turntable ass'y have been replaced.

- 1) Adjust the distance between the upper surface of the turntable ass'y and the mechanism chassis to 19.4±0.1 mm as shown in Fig. 10-6.
- 2) Fix them with the screw ㉕ after distance has been adjusted.

Fig. 10-6



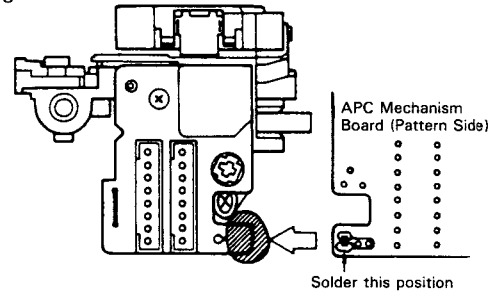
**G. Pick-Up Ass'y ⑩**

- 1) Take out the mechanism ass'y from unit.
- 2) Remove the clamp arm ass'y.
- 3) Remove the two screws ⑨ fixing the support rail ⑪ (with pick up ass'y ⑩).
- 4) Remove the pick up ass'y ⑩ from the support rail.

**Note:**

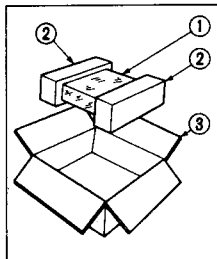
1. Note when removing the pick-up for repairing.  
Before removing the laser pick-up, short-circuit the terminals by soldering. This is to prevent damage to the pick-up during removal operation.
  - 1) Solder the pick-up terminals as shown in Fig. 10-7.
  - 2) Disconnect the two lead connectors.
2. Note when replacing the pick-up.
  - 1) Connect the two lead connectors of pick-up to the APC mechanism board.
  - 2) Unsolder the short-circuited terminal soldering for protection. (See Fig. 10-7)

Fig. 10-7 Pick-up Ass'y



**11. PACKING LIST**

Parts No.	Stock No.	Description
1	27306700	Vinyl Bag
2	27413700	Styrofoam Packing
3	27556020	Carton Case



**12. ACCESSORY LIST**

Parts No.	Stock No.	Description
		RS-1020 Remoto Controller
		SUM-3K Dry Battery
	07193400	Pin Plug Cord
	27636200	CS-1 Single CD Adaptor Ass'y
	49037600	Operating Instruction (*E•F•S)
	49037700	Operating Instruction (*G•I•Sw)

**\*Note:**

- E•F•S:** English•French and Spanish Version  
**G•I•Sw:** German•Italian and Swedish Version



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